

Amendments to the Specification

Please insert after the title, and before, "Federally Sponsored Research":

--Cross Reference to Related Application

This application is a continuation of and claims priority from U.S. Patent Application number 10/404,616, now issued Patent No. 6,686,261, filed April 1, 2003, which in turn is a continuation application of, and claims priority from, U.S. Patent Application number 09/899,586 filed July 3, 2001, now issued Patent No. 6,545,300, which in turn is a divisional application and claims priority from, U.S. Patent Application 09/441,753, filed November 17, 1999, now issued Patent No. 6,521,514, the entire disclosures of which are incorporated herein by reference.--

Please amend the abstract as shown below:

More specifically, gallium nitride semiconductor layers may be fabricated by etching an underlying gallium nitride layer on a sapphire substrate, to define at least one post in the underlying gallium nitride layer and at least one trench in the underlying gallium nitride layer. The at least one post includes a gallium nitride top and a gallium nitride sidewall. The at least one trench includes a trench floor. The gallium nitride sidewalls are laterally grown into the at least one trench, to thereby form a gallium nitride semiconductor layer. However, prior to performing the laterally growing step, the sapphire substrate and/or the underlying gallium nitride layer is treated to prevent growth of gallium nitride from the trench floor from interfering with the lateral growth of the gallium nitride sidewalls of the at least one post into the at least one trench. ~~Embodiments of gallium nitride semiconductor structures according to the present invention can include a sapphire substrate and an underlying gallium nitride layer on the sapphire substrate. The underlying gallium nitride layer includes therein at least one post and at least one trench. The at least one post each includes a gallium nitride top and a gallium nitride sidewall. The at least one trench includes a sapphire floor. A lateral gallium nitride layer extends laterally from the gallium nitride sidewall of the at least one post into the at least one trench. In a preferred embodiment, the at least one trench extends into the sapphire substrate such that the at~~

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~~least one post each includes a gallium nitride top, a gallium nitride sidewall and a sapphire sidewall and the at least one trench includes a sapphire floor. The sapphire floor preferably is free of a vertical gallium nitride layer thereon and the sapphire sidewall height to sapphire floor width ratio preferably exceeds about 1/4. A mask may be included on the sapphire floor and an aluminum nitride buffer layer also may be included between the sapphire substrate and the underlying gallium nitride layer. A mask also may be included on the gallium nitride top. The mask on the floor and the mask on the top preferably comprise same material.~~